NSS20201MR6T1G

20 V, 3 A, Low V_{CE(sat)} **NPN Transistor**

ON Semiconductor's e²PowerEdge family of low V_{CE(sat)} transistors are miniature surface mount devices featuring ultra low saturation voltage (V_{CE(sat)}) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical application are DC–DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V _{CEO}	20	V
Collector-Base Voltage	V _{CBO}	40	V
Emitter-Base Voltage	V _{EBO}	5.0	V
Collector Current – Continuous	Ι _C	2.0	A
Collector Current – Peak	I _{CM}	3.0	А

THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit		
Total Device Dissipation $T_A = 25^{\circ}C$	P _D (Note 1)	460	mW		
Derate above 25°C		3.7	mW/°C		
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$ (Note 1)	272	°C/W		
Total Device Dissipation $T_A = 25^{\circ}C$	P _D (Note 2)	780	mW		
Derate above 25°C		6.3	mW/°C		
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$ (Note 2)	160	°C/W		
Thermal Resistance, Junction-to-Lead #1	$R_{\theta JL}$ (Note 1)	48 40	°C/W °C/W		
Junction-to-Lead #1	R _{0JL} (Note 2)	40	-C/W		
Total Device Dissipation (Single Pulse < 10 s)	P _{Dsingle} (Note 2)	1.5	W		
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C		

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

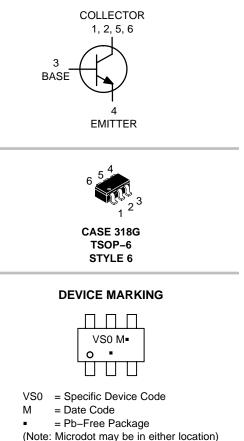
FR-4 @ 100 mm2, 2 oz copper traces.
 FR-4 @ 500 mm2, 2 oz copper traces.



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20 VOLTS **3.0 AMPS** $\begin{array}{l} \text{NPN LOW V}_{\text{CE(sat)}} \text{ TRANSISTOR} \\ \text{EQUIVALENT R}_{\text{DS(on)}} \text{ 100 m} \Omega \end{array}$



ORDERING INFORMATION

Device	Package	Shipping [†]
NSS20201MR6T1G	TSOP-6 (Pb-Free)	3000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS				-	
Collector – Emitter Breakdown Voltage $(I_C = 10 \text{ mA}, I_B = 0)$	V _{(BR)CEO}	20	-	_	V
Collector-Base Breakdown Voltage $(I_C = 0.1 \text{ mA}, I_E = 0)$	V _{(BR)CBO}	40	_	-	V
Emitter – Base Breakdown Voltage $(I_E = 0.1 \text{ mA}, I_C = 0)$	V _{(BR)EBO}	5.0	_	_	V
Collector Cutoff Current ($V_{CB} = 40 \text{ V}, I_E = 0$)	I _{CBO}	-	_	0.1	μΑ
Collector–Emitter Cutoff Current (V _{CES} = 20 V)	ICES	_	_	0.1	μΑ
Emitter Cutoff Current (V _{EB} = 5.0 V)	I _{EBO}	_		0.1	μΑ
ON CHARACTERISTICS		-		-	
DC Current Gain (Note 3) ($I_C = 1.0 \text{ mA}, V_{CE} = 5.0 \text{ V}$) ($I_C = 0.5 \text{ A}, V_{CE} = 5.0 \text{ V}$) ($I_C = 1.0 \text{ A}, V_{CE} = 5.0 \text{ V}$)	h _{FE}	300 300 200	- - -	- - -	
	V _{CE(sat)}	- - -		0.150 0.100 0.025	V
Base – Emitter Saturation Voltage (Note 3) $(I_C = 1.0 \text{ A}, I_B = 0.1 \text{ A})$	V _{BE(sat)}	-	-	0.95	V
Base – Emitter Turn–on Voltage (Note 3) $(I_C = 1.0 \text{ A}, V_{CE} = 2.0 \text{ V})$	V _{BE(on)}	-	-	0.90	V
Cutoff Frequency ($I_C = 100 \text{ mA}, V_{CE} = 5.0 \text{ V}, f = 100 \text{ MHz}$	f _T	200	-	_	MHz
Output Capacitance (f = 1.0 MHz)	C _{obo}	_	_	15	pF

3. Pulsed Condition: Pulse Width \leq 300 µsec, Duty Cycle \leq 2%.

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TSOP-6 CASE 318G-02 ISSUE V DATE 12 JUN 2012 SCALE 2:1 NOTES: D 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. 2 Η MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM З. LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSIONS D 4 ¥ 12 4 GAUGE E1 Е AND E1 ARE DETERMINED AT DATUM H. 5. PIN ONE INDICATOR MUST BE LOCATED IN THE INDICATED ZONE. 2 4 MILLIMETERS М NOTE 5 b DIM MIN NOM MAX 0.90 1.10 DETAIL Z Α 1.00 A1 0.01 0.06 0.10 b 0.25 0.38 0.50 с 0.10 0 18 0.26 D 2.90 3.00 3.10 С Е 2.50 2.75 Α 3.00 $|\cap$ 0.05 E1 1.30 1.50 1.70 e L 0.85 0.95 1.05 0.40 0.20 0.60 Δ1 L2 M 0.25 BSC DETAIL Z 10° 0 STYLE 2: PIN 1. EMITTER 2 2. BASE 1 STYLE 3: PIN 1. ENABLE 2. N/C STYLE 4: PIN 1. N/C 2. V in STYLE 5: PIN 1. EMITTER 2 2. BASE 2 STYLE 6: PIN 1. COLLECTOR 2. COLLECTOR STYLE 1: PIN 1. DRAIN 2. DRAIN COLLECTOR 1 EMITTER 1 3. GATE 4. SOURCE З. 3. R BOOST 4. Vz 3. NOT USED 4. GROUND 3. COLLECTOR 1 4. EMITTER 1 3. BASE 4. EMITTER 4. 5. ENABLE 6. LOAD 5. COLLECTOR 6. COLLECTOR 5. DRAIN 5. BASE 2 5. V in 5. BASE 1 6. V out 6. COLLECTOR 2 6. COLLECTOR 2 6. DRAIN STYLE 10: STYLE 11: STYLE 8: STYLE 9: STYLE 12: STYLE 7 PIN 1. COLLECTOR PIN 1. Vbus PIN 1. LOW VOLTAGE GATE PIN 1. D(OUT)+ PIN 1. SOURCE 1 PIN 1. I/O 2. DRAIN 2 2. GROUND 2. COLLECTOR 2. D(in) 2. DRAIN 2. GND 3. D(in)+ 4. D(out)+ 3. SOURCE 4. DRAIN 3. D(OUT)-4. D(IN)-3. BASE DRAIN 2 3. I/O З. 4 N/C 4 I/O 4 SOURCE 2 5. COLLECTOR 5. D(out) 6. GND 5. 5. VBUS 6. D(IN)+ 5. GATE 1 6. DRAIN 1/GATE 2 5. VCC 6. I/O DRAIN 6. HIGH VOLTAGE GATE 6. EMITTER STYLE 13: PIN 1. GATE 1 STYLE 14: PIN 1. ANODE STYLE 15: PIN 1. ANODE STYLE 16: PIN 1. ANODE/CATHODE STYLE 17: PIN 1. EMITTER 2. SOURCE 2 2. SOURCE 2. SOURCE 2. BASE 2. BASE 3 EMITTER 3 ANODE/CATHODE 3. GATE 2 3 GATE 3 GATE 4. DRAIN 2 4. CATHODE/DRAIN 4. DRAIN 4 COLLECTOR ANODE 5. CATHODE/DRAIN CATHODE 5. SOURCE 1 5. N/C 5. ANODE 5. DRAIN 1 6. CATHODE/DRAIN 6. CATHODE CATHODE COLLECTOR 6. 6. 6. GENERIC RECOMMENDED **MARKING DIAGRAM*** SOLDERING FOOTPRINT* 0.60 XXXAYW= XXX M= 0 o 1LI 6X 3.20 IC STANDARD 0.95 XXX = Specific Device Code XXX = Specific Device Code А =Assembly Location Μ = Date Code Y = Pb-Free Package = Year W = Work Week 0.95 = Pb-Free Package PITCH DIMENSIONS: MILLIMETERS *This information is generic. Please refer to device data *For additional information on our Pb-Free strategy and soldering sheet for actual part marking. Pb-Free indicator, "G" details, please download the ON Semiconductor Soldering and or microdot "•", may or may not be present. Some Mounting Techniques Reference Manual, SOLDERRM/D. products may not follow the Generic Marking. Electronic versions are uncontrolled except when accessed directly from the Document Repository. DOCUMENT NUMBER: 98ASB14888C Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.

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